

L Number	Hits	Search Text	DB	Time stamp
1	70975	heat\$4 near3 mold\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 15:59
2	112037	heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 15:59
3	35248	(heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 16:00
4	19966	((heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature) same (low\$4 or high\$4 or decreas\$4 or increas\$4 or rais\$4 or great\$4 or less\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 16:01
5	15	((((heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature) same (low\$4 or high\$4 or decreas\$4 or increas\$4 or rais\$4 or great\$4 or less\$4)) same (thermal adj cycling)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 16:04
6	7309	((((heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature) same (low\$4 or high\$4 or decreas\$4 or increas\$4 or rais\$4 or great\$4 or less\$4)) same (press\$4 or urg\$4 or impress\$4 or imprint)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 16:04
7	2784	6.ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 16:05
8	772	temperature adj tool	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 16:05
9	22	((((heat\$4 near3 (mould\$4 or mold\$4 or emboss\$4 or imprint\$4)) same temperature) same (low\$4 or high\$4 or decreas\$4 or increas\$4 or rais\$4 or great\$4 or less\$4)) same (press\$4 or urg\$4 or impress\$4 or imprint)) and (temperature adj tool)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 16:05

L Number	Hits	Search Text	DB	Time stamp
1	2234	(eliminat\$4 or reduc\$4 or lower\$4) with (thermal adj cycl\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 15:39
2	106	((eliminat\$4 or reduc\$4 or lower\$4) with (thermal adj cycl\$4)) same (imprint\$4 or emboss\$4 or stamp\$4 or mold\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 15:21
3	70	((((eliminat\$4 or reduc\$4 or lower\$4) with (thermal adj cycl\$4)) same (imprint\$4 or emboss\$4 or stamp\$4 or mold\$4)) same (preheat\$4 or heat\$4 or temperature or c or f)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 15:26
4	4	(imprint\$4) with (thermal adj cycl\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 15:40
5	3	chou.in. and alanko	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/30 15:41